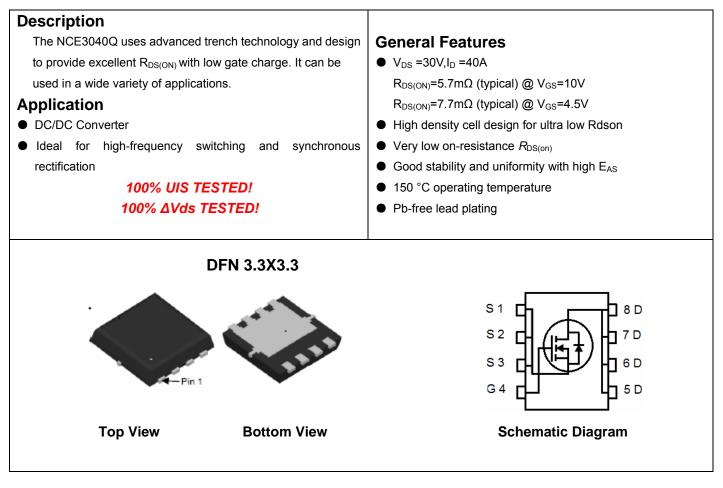


# NCE N-Channel Enhancement Mode Power MOSFET



### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE3040Q	NCE3040Q	DFN 3.3x3.3-8L	-	-	-

### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous (Note 1)	Ι <sub>D</sub>	40	А
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	28.3	A
Pulsed Drain Current	I <sub>DM</sub>	160	A
Maximum Power Dissipation	PD	35	W
Derating factor		0.28	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	150	mJ
Operating Junction and Storage Temperature Range	$T_{J},T_{STG}$	-55 To 150	്റ

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	3.6	°C/W	]
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### Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	30	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	1	1.5	2.5	V
Desia Source On State Desistence		V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	5.7	7.0	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	7.7	9.5	
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =20A	20	-	-	S
Dynamic Characteristics (Note4)						•
Input Capacitance	C <sub>lss</sub>		-	1400	-	PF
Output Capacitance	C <sub>oss</sub>	- V <sub>DS</sub> =15V,V <sub>GS</sub> =0V, F=1.0MHz	-	205	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	177	-	PF
Switching Characteristics (Note 4)		·				
Turn-on Delay Time	t <sub>d(on)</sub>		-	9	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =15V,I <sub>D</sub> =20A	-	8	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =6 $\Omega$	-	28	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	5	-	nS
Total Gate Charge	Qg		-	32.3	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =15V,I <sub>D</sub> =20A, V <sub>GS</sub> =10V	-	4.9	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	6.9	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-	0.85	1.2	V
Diode Forward Current	Is		-	-	40	А
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, I <sub>F</sub> = 20A	-	-	27	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	-	20	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				y LS+LD)

#### Notes:

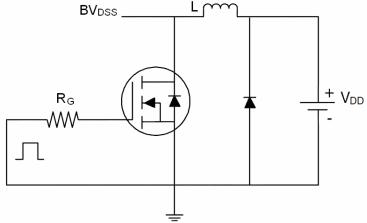
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25  $^{\circ}$ C,V<sub>DD</sub>=15V,V<sub>G</sub>=10V,L=0.5mH,Rg=25 $\Omega$



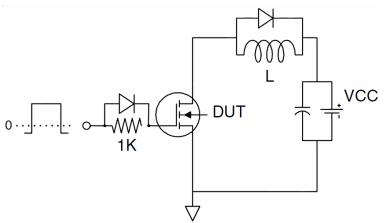
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# Test Circuit

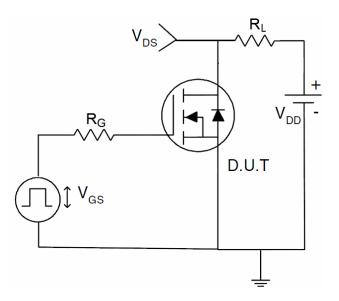
1) E<sub>AS</sub> Test Circuits



2) Gate Charge Test Circuit

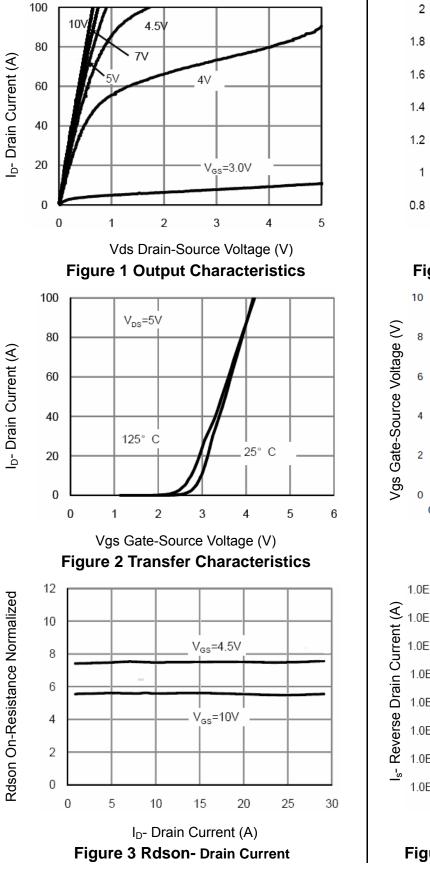


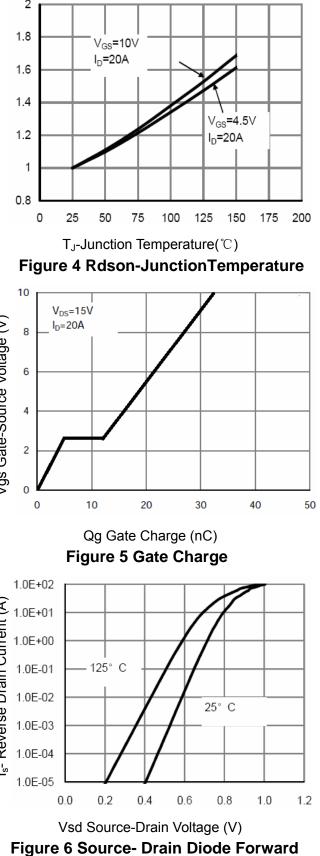
3) Switch Time Test Circuit













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# NCE3040Q

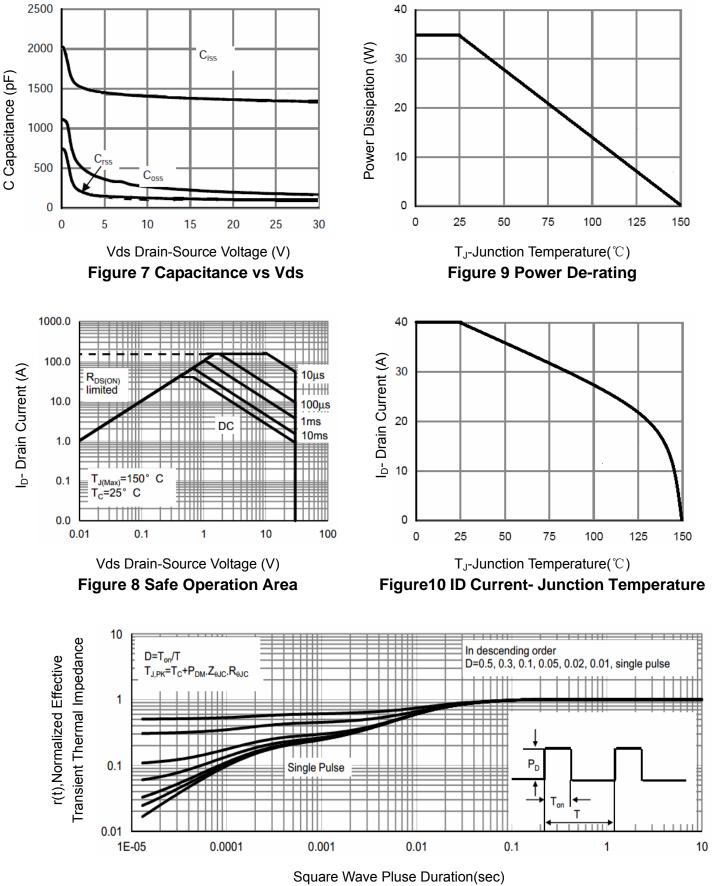
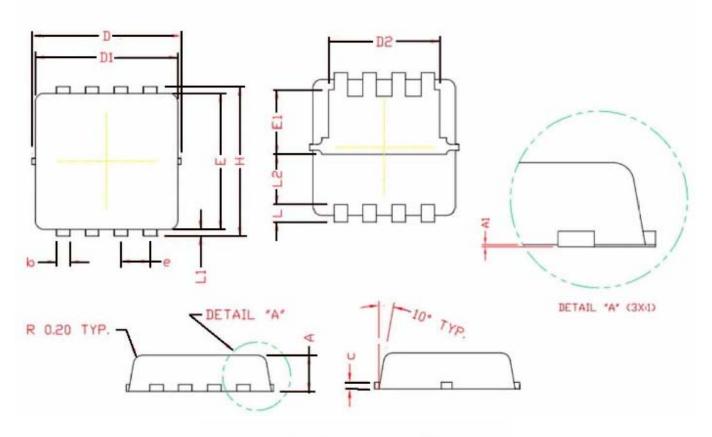


Figure 11 Normalized Maximum Transient Thermal Impedance



DFN3.3X3.3-8L Package Information



## COMMON DIMENSIONS

SYMBOL	MIN	NOM	MAX		
A	0.70	0.80	0.90		
A1	0.00	0.03	0.05		
b	0.24	0.30	0.35		
с	0.10	0.15	0.20		
D	3.25	3.32	3.40		
D1	3.05	3.15	3.25		
D2	2.40	2.50	2.60		
E	3.00	3.10	3.20		
E1	1.35	1.45	1.55		
е	0.65 BSC.				
Н	3.20	3.30	3.40		
L	0.30	0.40	0.50		
L1	0.10	0.15	0.20		
L2	1	.13 REF			

### (UNITS OF MEASURE=MILLIMETER)



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